

Transmissive Optical Sensor

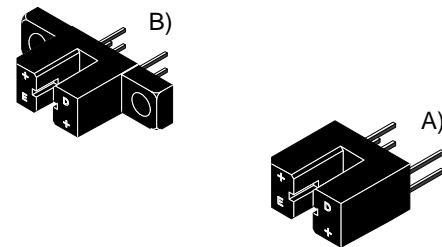
Description

This device has a compact construction where the emitting-light sources and the detectors are located face to face on the same optical axes.

The operating wavelength is 950 nm. The detector consists of a photologic-IC with Schmitt trigger and open collector output.

Applications

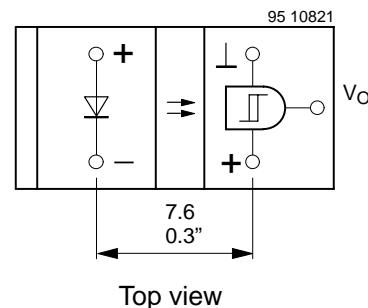
- Detection of opaque material, documents etc.
- Paper position sensor in copy machines
- Position sensor for shaft encoder



15132

Features

- Output: 'LOW' when infrared beam is not interrupted
- Inverter-open collector
- TTL compatible
- Built-in voltage regulator
- Plastic polycarbonate case, protected against ambient light
- No adjustment necessary
- Two package variations



Handling Precautions

Connect a capacitor C of more than 100 nF between V_{S1} and ground in order to stabilize power supply voltage!

Order Instruction

| Ordering Code | Resolution (mm) / Aperture (mm) | Remarks |
|-------------------------|---------------------------------|-------------------------|
| TCSS1100 ^A) | 0.6 / 1.0 | No mounting flags |
| TCSS2100 ^B) | 0.6 / 1.0 | With two mounting flags |

Absolute Maximum Ratings

Input (Emitter)

| Parameter | Test Conditions | Symbol | Value | Unit |
|-----------------------|---------------------------|-----------|-------|------|
| Reverse voltage | | V_R | 6 | V |
| Forward current | | I_F | 60 | mA |
| Forward surge current | $t_p \leq 10\mu s$ | I_{FSM} | 3 | A |
| Power dissipation | $T_{amb} \leq 25^\circ C$ | P_V | 100 | mW |
| Junction temperature | | T_j | 100 | °C |

Output (Detector)

| Parameter | Test Conditions | Symbol | Value | Unit |
|----------------------|---------------------------|----------|-------|------|
| Supply voltages | | V_{S1} | 6.5 | V |
| | | V_{S2} | 18 | V |
| Output current | | I_O | 20 | mA |
| Power dissipation | $T_{amb} \leq 25^\circ C$ | P_V | 250 | mW |
| Junction temperature | | T_j | 100 | °C |

Coupler

| Parameter | Test Conditions | Symbol | Value | Unit |
|---------------------------|------------------------------|-----------|-------------|------|
| Total power dissipation | $T_{amb} \leq 25^\circ C$ | P_{tot} | 250 | mW |
| Ambient temperature range | | T_{amb} | -25 to +85 | °C |
| Storage temperature range | | T_{stg} | -40 to +100 | °C |
| Soldering temperature | 2 mm from case, $t \leq 5$ s | T_{sd} | 260 | °C |

Electrical Characteristics ($T_{amb} = 25^\circ C$)

Input (Emitter)

| Parameter | Test Conditions | Symbol | Min. | Typ. | Max. | Unit |
|----------------------|-------------------------|--------|------|------|------|------|
| Forward voltage | $I_F = 50$ mA | V_F | | 1.25 | 1.6 | V |
| Junction capacitance | $V_R = 0$, $f = 1$ MHz | C_J | | 50 | | pF |

Output (Detector)

| Parameter | Test Conditions | Symbol | Min. | Typ. | Max. | Unit |
|----------------------|-----------------|----------|------|------|------|------|
| Supply voltage range | | V_{S1} | 4.75 | | 5.25 | V |
| | | V_{S2} | 4.0 | | 16 | V |

Coupler

| Parameter | Test Conditions | Symbol | Min. | Typ. | Max. | Unit |
|-------------------------|--|--------------------|------|------|------|------|
| Supply current | $V_{S1} = 16$ V | I_{S1} | | 3 | 5 | mA |
| Output current | $V_{S1} = V_{S2} = 16$ V, $I_F = 0$ | I_{OH} | | | 1 | μA |
| Input threshold current | $V_{S1} = 5$ V | I_{FT} | | 5 | 10 | mA |
| Hysteresis | $V_{S1} = 5$ V | I_{Foff}/I_{Fon} | | 80 | | % |
| Output voltage | $I_{OL} = 16$ mA, $I_F \geq I_{TF}$, $V_{S1} = 5$ V | V_{OL} | | 0.15 | 0.4 | V |
| Switching frequency | $I_F = 3x I_{FT}$, $V_{S1} = V_{S2} = 5$ V, $R_L = 1$ kΩ | f_{sw} | | 200 | | kHz |

Switching Characteristics

| Parameter | Test Conditions | Symbol | Typ. | Unit |
|---------------|--|-----------|------|---------------|
| Rise time | $V_{S1} = V_{S2} = 5 \text{ V}$, $I_F = 3 \times I_{FT}$, $R_L = 1 \text{ k}\Omega$ (see figure 1) | t_r | 50.0 | ns |
| Turn-on time | | t_{on} | 1.0 | μs |
| Fall time | | t_f | 20.0 | ns |
| Turn-off time | | t_{off} | 3.0 | μs |

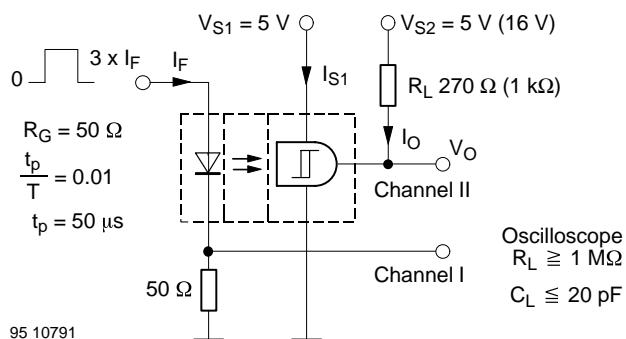


Figure 1. Test circuit for: t_r , t_{on} , t_f , t_{off}

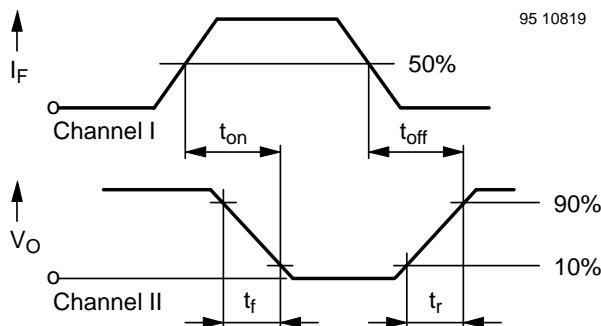


Figure 2. Pulse diagram

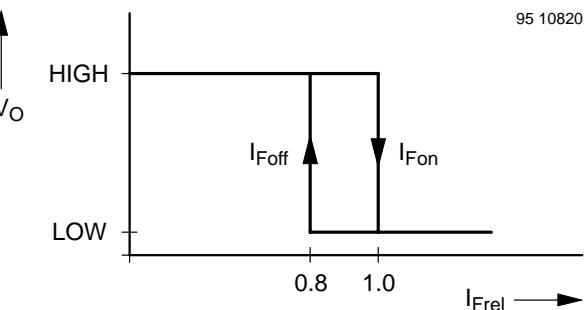
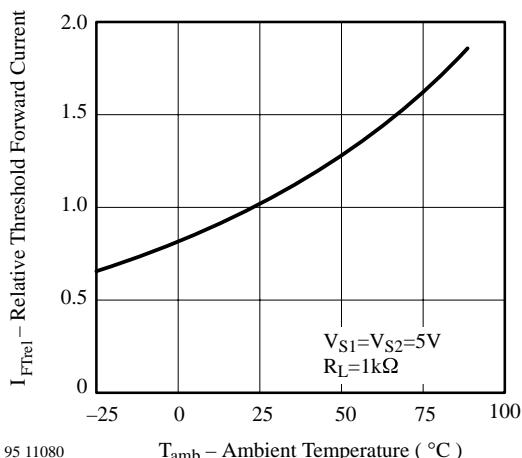
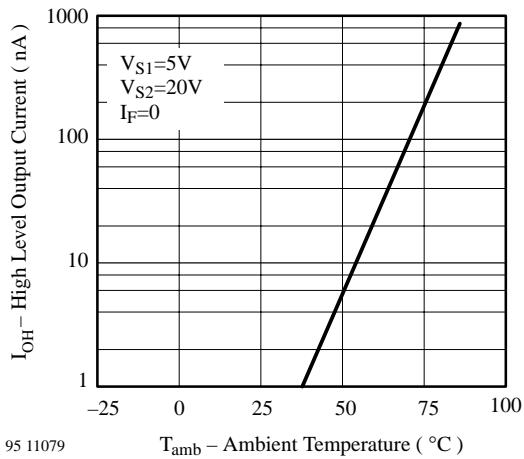
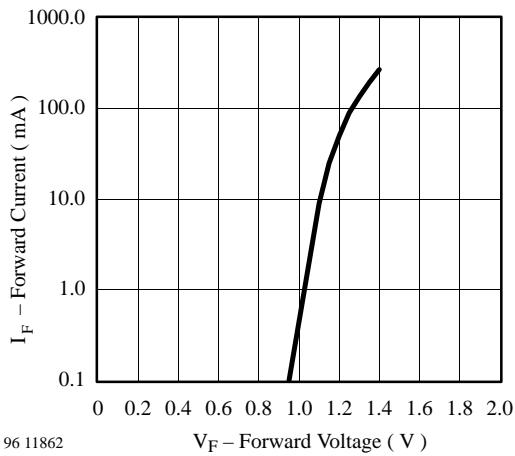
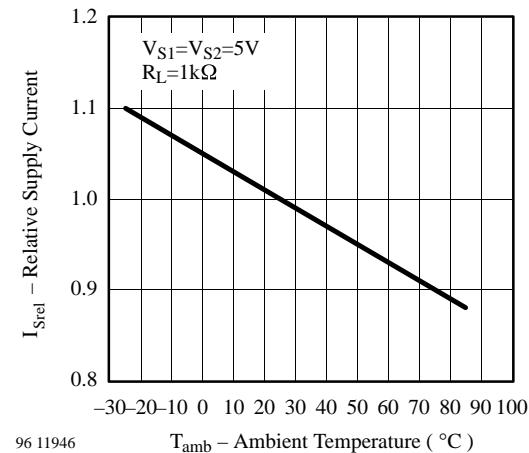
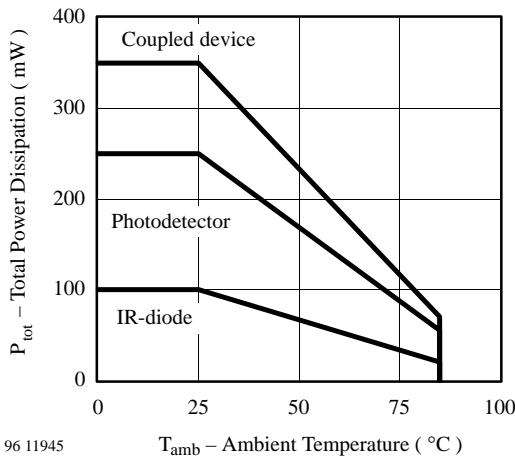
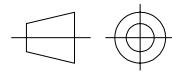
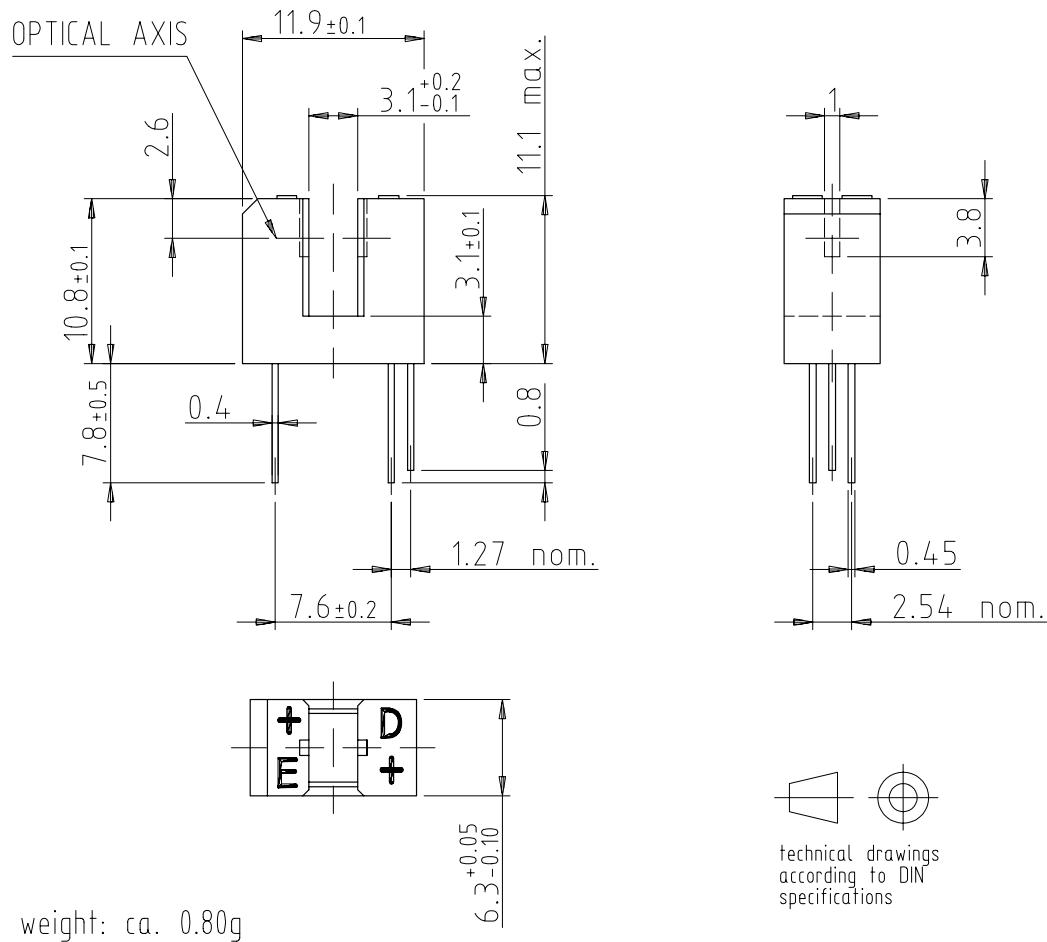


Figure 3. Hysteresis

Typical Characteristics ($T_{amb} = 25^{\circ}\text{C}$, unless otherwise specified)

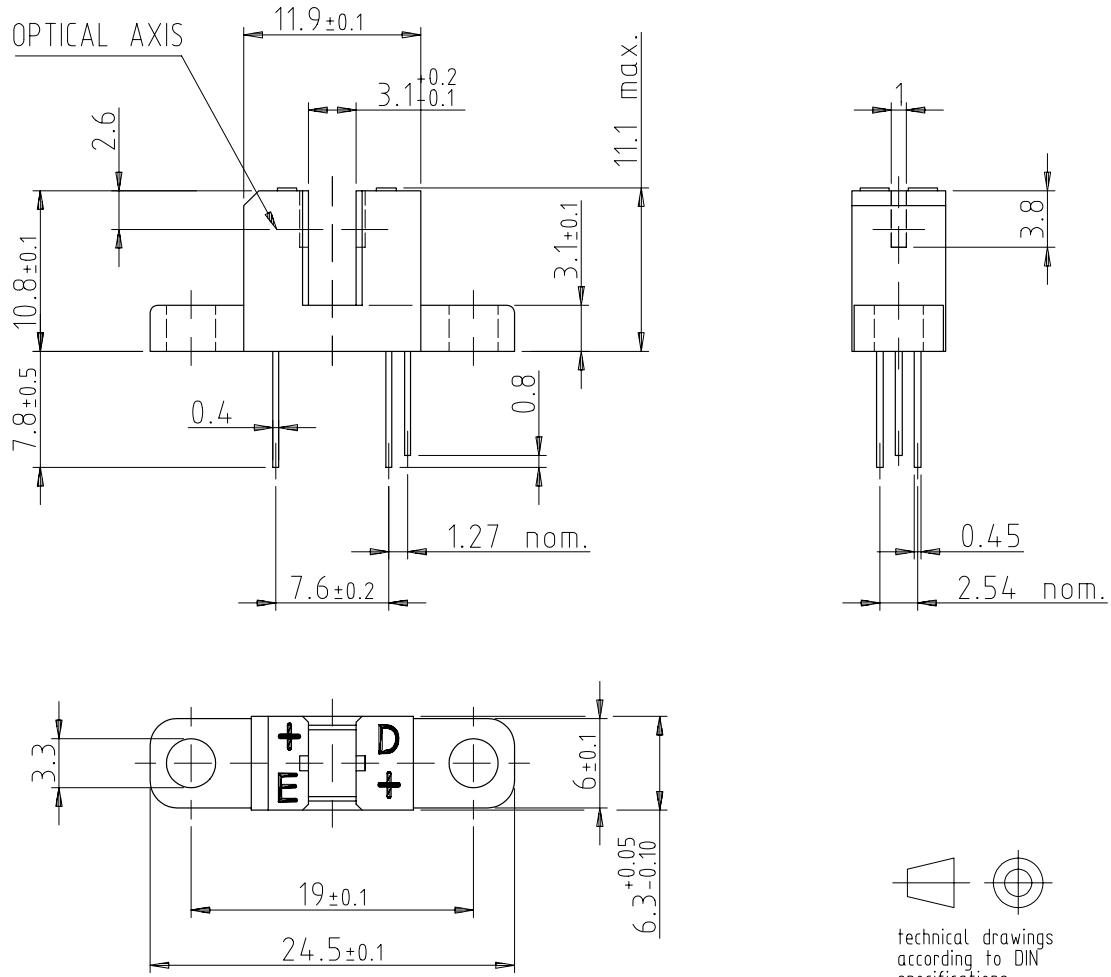


Dimensions of TCSS1100 in mm


technical drawings
according to DIN
specifications

96 12096

Dimensions of TCSS2100 in mm



weight: ca. 0.90g

96 12097



Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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